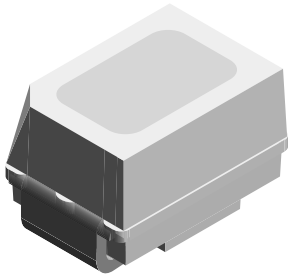
Power Mini SMD LED



19226

FEATURES

- SMD LEDs with exceptional brightness
- Luminous intensity categorized
- Compatible with automatic placement equipment
- IR reflow soldering
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packing unit $I_{Vmax.}/I_{Vmin.} \leq 1.6$
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

Pb-free

e3

RoHS COMPLIANT

HALOGEN FREE

GREEN (5-2008)

DESCRIPTION

The new MiniLED series have been designed in a small white SMT package. The feature of the device is the very small package 2.3 mm x 1.3 mm x 1.4 mm. The MiniLED is an obvious solution for small-scale, high-power products that are expected to work reliability in an arduous environment. This is often the case in automotive and industrial application.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD MiniLED
- Product series: power
- Angle of half intensity: ± 60°

APPLICATIONS

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches, and symbols

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I_F (mA)	WAVELENGTH (nm)			at I_F (mA)	FORWARD VOLTAGE (V)			at I_F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMK2300-GS08	Super-red	35.5	90	-	20	-	630	-	20	-	1.9	2.6	20	AlInGaP on GaAs
VLMF2300-GS08	Soft orange	56	112	-	20	598	605	611	20	-	2.0	2.6	20	AlInGaP on GaAs
VLME2300-GS08	Yellow	56	112	-	20	581	588	594	20	-	2.0	2.6	20	AlInGaP on GaAs

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)
VLMK2300, VLMF2300, VLME2300

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage (1)		V_R	5	V
DC forward current	$T_{amb} \leq 80$ °C	I_F	30	mA
Single forward current	$t_p \leq 10$ µs	I_{FSM}	0.1	A
Power dissipation	$T_{amb} \leq 80$ °C	P_V	80	mW
Junction temperature		T_j	+125	°C
Operating temperature range		T_{amb}	-40 to +100	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	According to IPC 9501	T_{sd}	245	°C
Thermal resistance junction/ambient	Mounted on PC board (pad size > 5 mm²)	R_{thJA}	580	K/W

Note

(1) Driving the LED in reverse direction is suitable for a short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)
VLMK2300, SUPER-RED

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity (1)	I_F = 20 mA	I_V	35.5	90	-	mcd
Dominant wavelength	I_F = 20 mA	λ_d	-	630	-	nm
Peak wavelength	I_F = 20 mA	λ_p	-	643	-	nm
Angle of half intensity	I_F = 20 mA	φ	-	± 60	-	deg
Forward voltage	I_F = 20 mA	V_F	-	1.9	2.6	V
Reverse voltage	I_R = 10 µA	V_R	5	-	-	V
Junction capacitance	V_R = 0 V, f =1 MHz	C_j	-	15	-	pF

Note
(1) In one packing unit $I_{Vmax.}/I_{Vmin.} \leq 1.6$

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)
VLMF2300, SOFT ORANGE

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity (1)	I_F = 20 mA	I_V	56	112	-	mcd
Dominant wavelength	I_F = 20 mA	λ_d	598	605	611	nm
Peak wavelength	I_F = 20 mA	λ_p	-	610	-	nm
Angle of half intensity	I_F = 20 mA	φ	-	± 60	-	deg
Forward voltage	I_F = 20 mA	V_F	-	2.0	2.6	V
Reverse voltage	I_R = 10 µA	V_R	5	-	-	V
Junction capacitance	V_R = 0 V, f =1 MHz	C_j	-	15	-	pF

Note
(1) In one packing unit $I_{Vmax.}/I_{Vmin.} \leq 1.6$

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)
VLME2300, YELLOW

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity (1)	I_F = 20 mA	I_V	56	112	-	mcd
Dominant wavelength	I_F = 20 mA	λ_d	581	588	594	nm
Peak wavelength	I_F = 20 mA	λ_p	-	590	-	nm
Angle of half intensity	I_F = 20 mA	φ	-	± 60	-	deg
Forward voltage	I_F = 20 mA	V_F	-	2.0	2.6	V
Reverse voltage	I_R = 10 µA	V_R	5	-	-	V
Junction capacitance	V_R = 0 V, f =1 MHz	C_j	-	15	-	pF

Note
(1) In one packing unit $I_{Vmax.}/I_{Vmin.} \leq 1.6$

LUMINOUS INTENSITY/FLUX			
GROUP	LUMINOUS INTENSITY I_V (mcd)		
STANDARD	OPTIONAL	MIN.	MAX.
N	1	-	-
	2	35.5	45
P	1	45	56
	2	56	71
Q	1	71	90
	2	90	112
R	1	112	140
	2	140	180
S	1	180	224
	2	224	280
T	1	280	355
	2	355	450

Note

- Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.
  The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).
  In order to ensure availability, single brightness groups will not be orderable.
  In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.
  In order to ensure availability, single wavelength groups will not be orderable.

CROSSING TABLE	
VISHAY	OSRAM
VLMK2300	LSM676
VLMF2300	LOM676
VLME2300	LYM676

COLOR CLASSIFICATION				
GROUP	DOM. WAVELENGTH (nm)			
	SOFT ORANGE		YELLOW	
	MIN.	MAX.	MIN.	MAX.
1	598	601	581	584
2	600	603	583	586
3	602	605	585	588
4	604	607	587	590
5	606	609	589	592
6	608	611	591	594

Note

- Wavelengths are tested at a current pulse duration of 25 ms.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

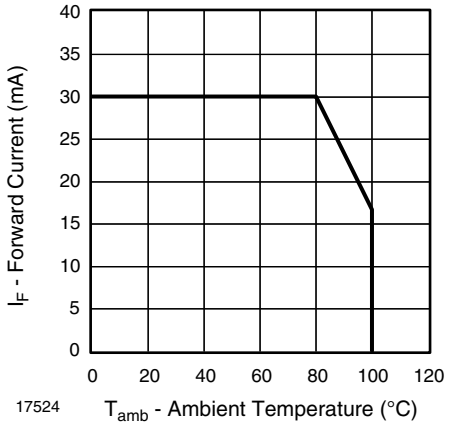


Fig. 1 - Forward Current vs. Ambient Temperature

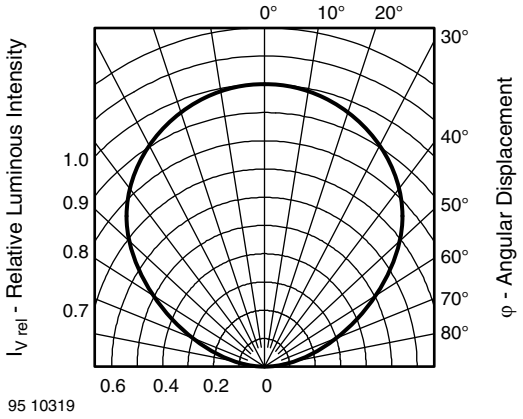


Fig. 2 - Relative Luminous Intensity vs. Angular Displacement

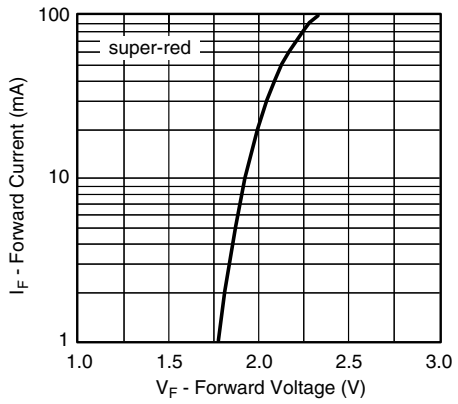


Fig. 3 - Forward Current vs. Forward Voltage

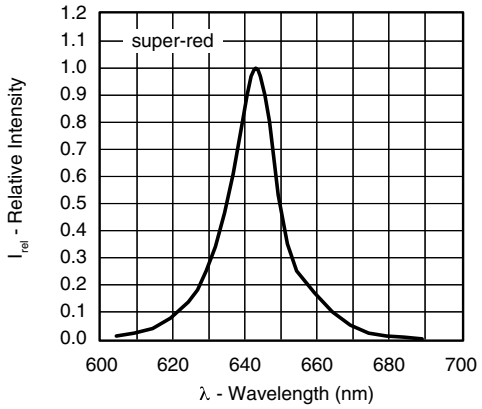


Fig. 6 - Relative Intensity vs. Wavelength

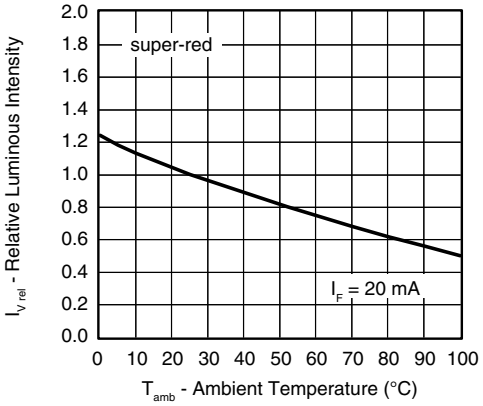


Fig. 4 - Relative Luminous Intensity vs. Ambient Temperature

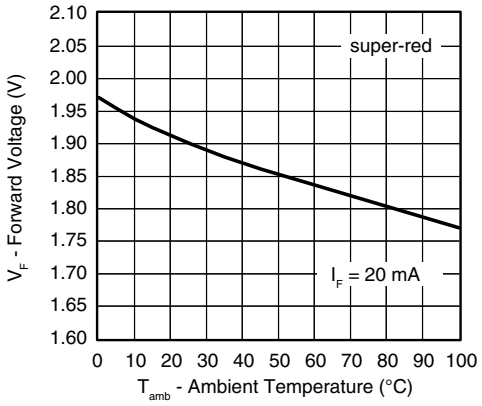


Fig. 7 - Forward Voltage vs. Ambient Temperature

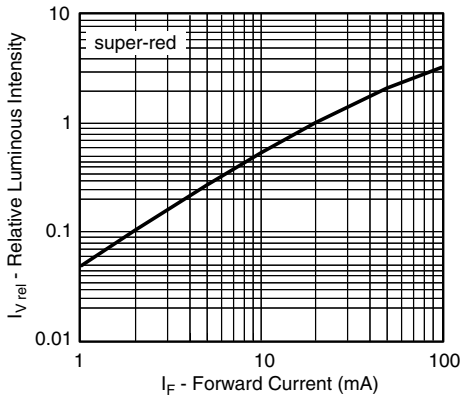


Fig. 5 - Relative Luminous Intensity vs. Forward Current

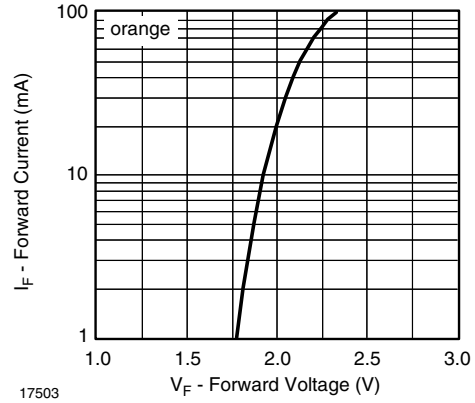


Fig. 8 - Forward Current vs. Forward Voltage

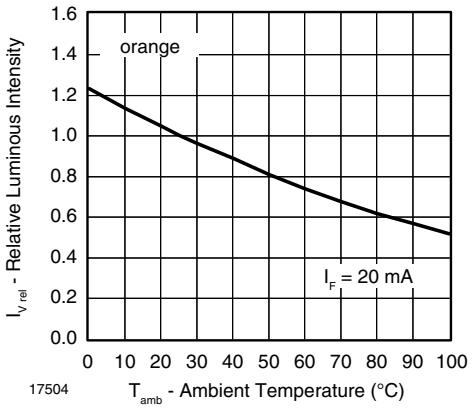


Fig. 9 - Relative Luminous Intensity vs. Ambient Temperature

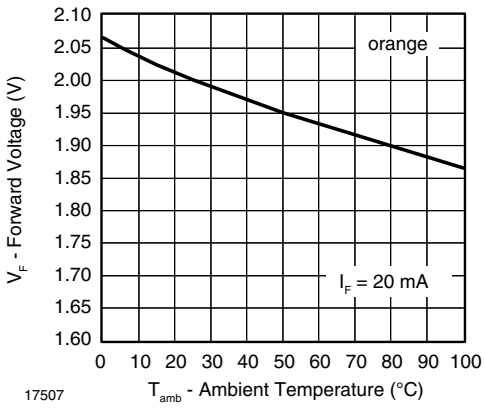


Fig. 12 - Forward Voltage vs. Ambient Temperature

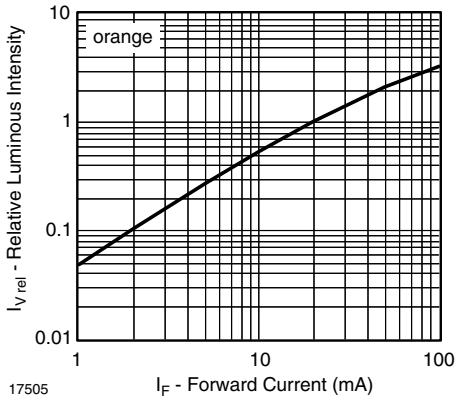


Fig. 10 - Relative Luminous Intensity vs. Forward Current

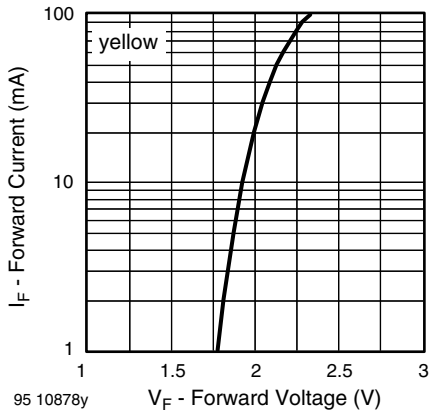


Fig. 13 - Forward Current vs. Forward Voltage

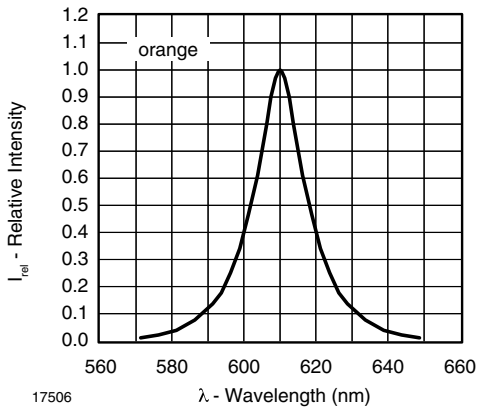


Fig. 11 - Relative Intensity vs. Wavelength

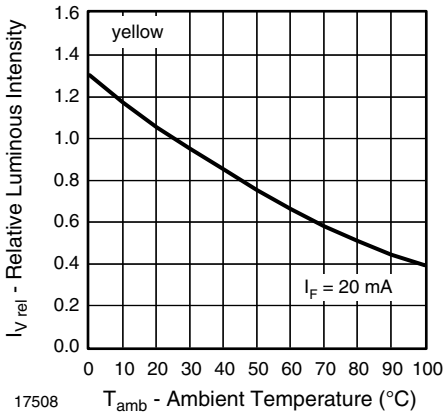


Fig. 14 - Relative Luminous Intensity vs. Ambient Temperature

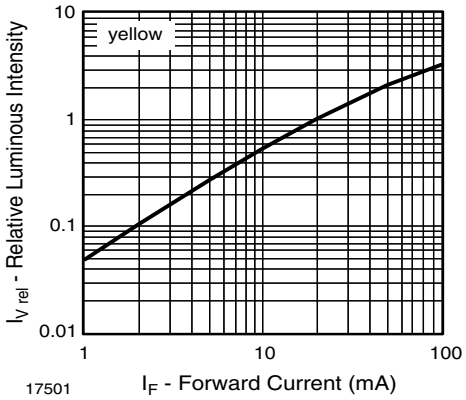


Fig. 15 - Relative Luminous Intensity vs. Forward Current

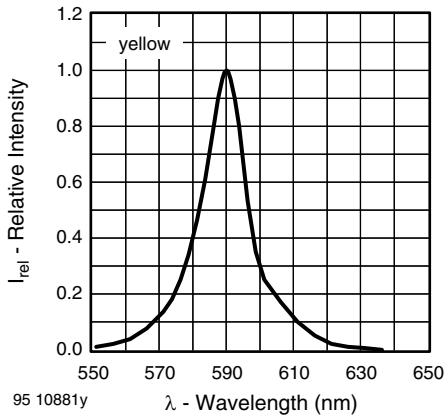


Fig. 16 - Relative Intensity vs. Wavelength

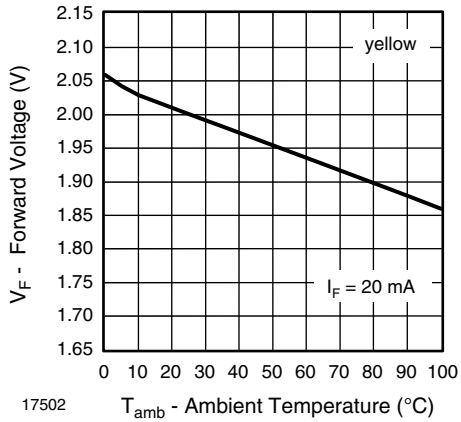
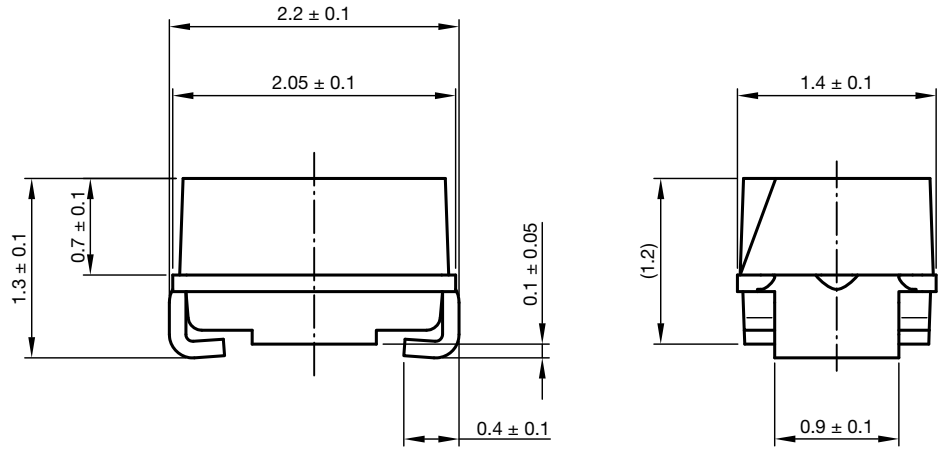
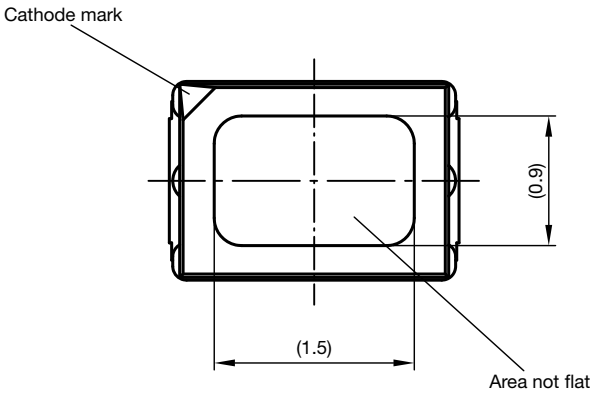


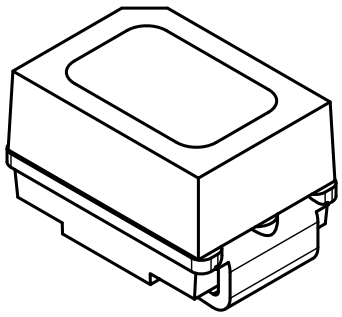
Fig. 17 - Forward Voltage vs. Ambient Temperature

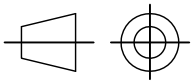
PACKAGE DIMENSIONS in millimeters



Not indicated tolerances ± 0.2

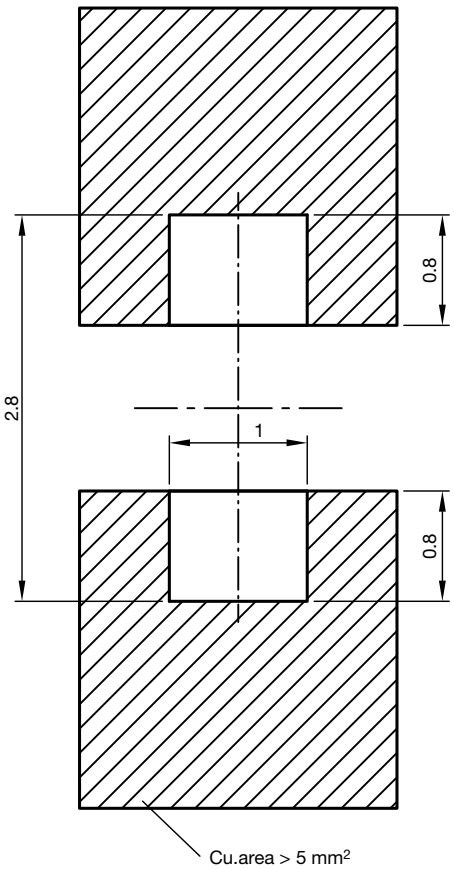






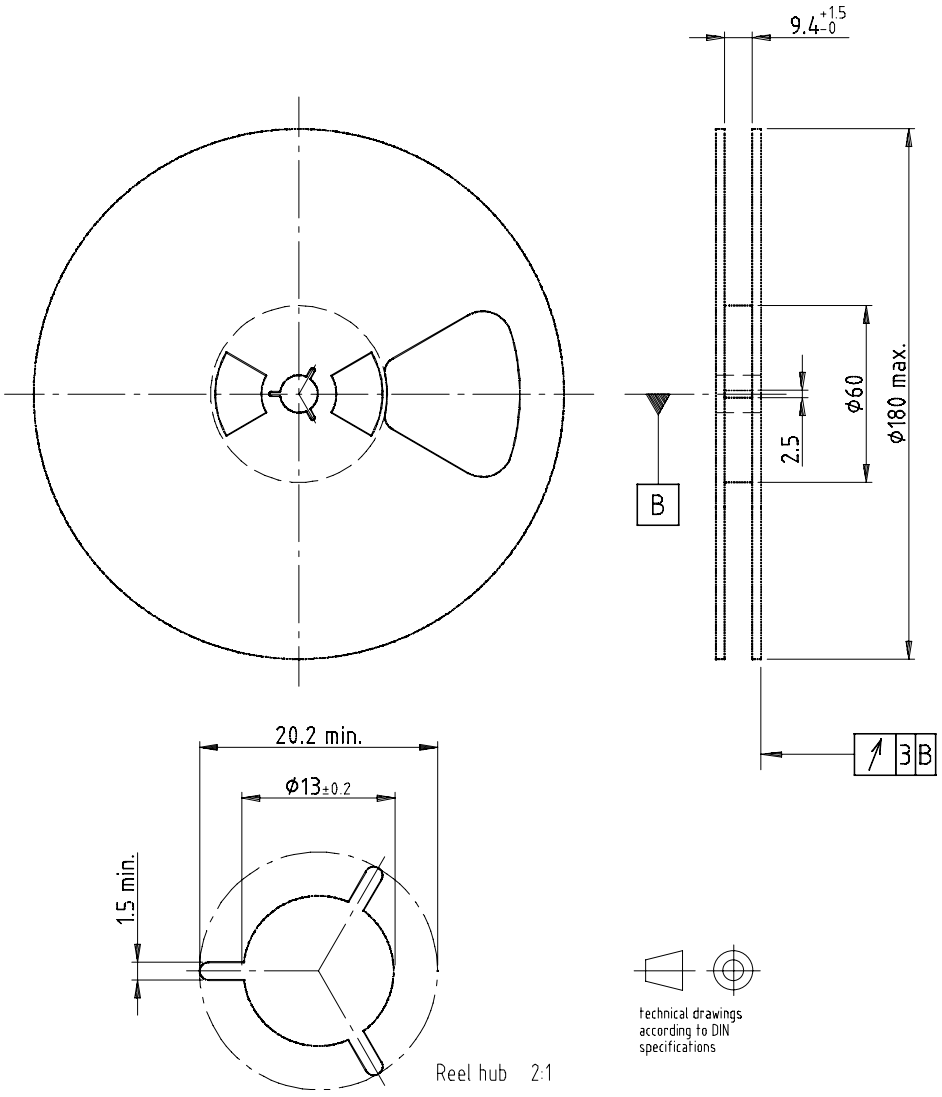
technical drawings
according to DIN
specifications

Proposed pad layout
(for reference only)



Drawing-No.: 6.541-5069.01-4
Issue: 2; 24.11.14

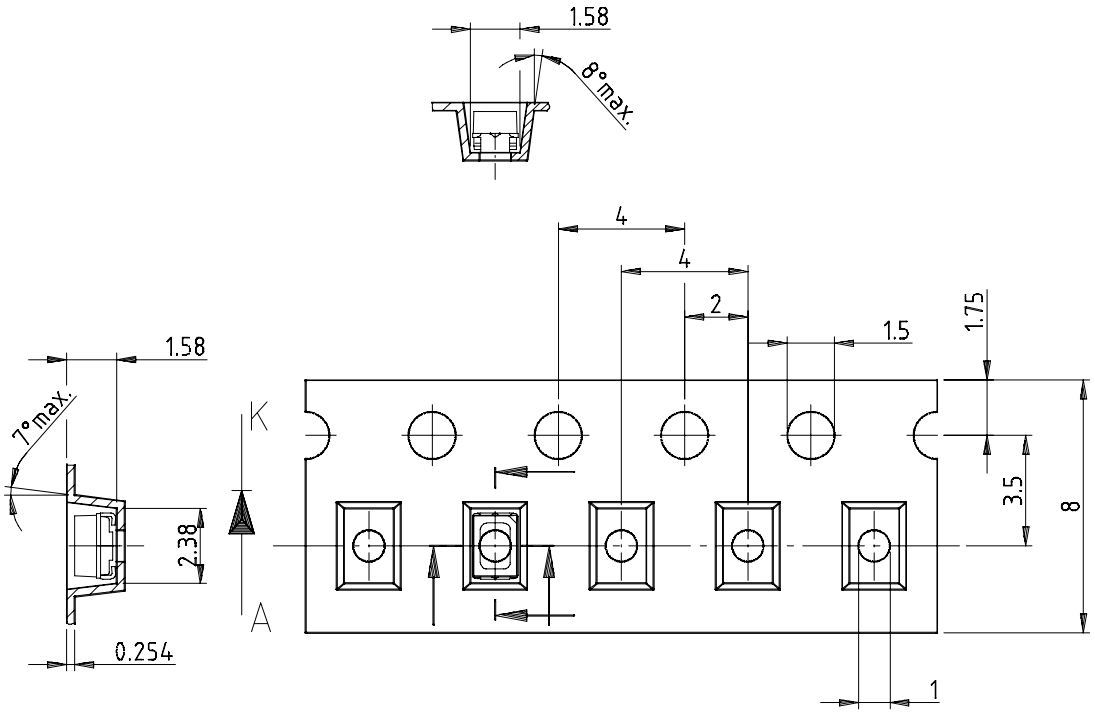
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5051.V5-4
Issue: 1; 25.07.02

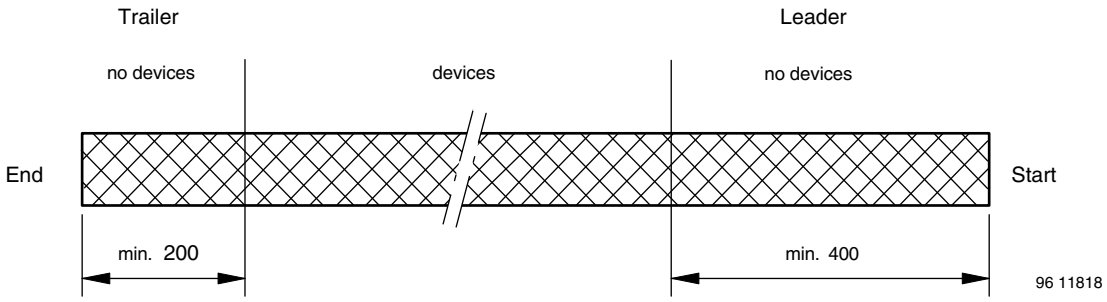
16938

TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5266.01-4
Issue: 1; 05.06.02
16939

LEADER AND TRAILER DIMENSIONS in millimeters



GS08 = 3000 pcs

COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min ± 10 mm/min

165° to 180° peel angle

LABEL

Standard Bar Code Labels for Finished Goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	**ABBREVIATION**	**LENGTH**
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	**TYPE**	**LENGTH**
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	**TYPE**	**LENGTH**
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

SOLDERING PROFILE

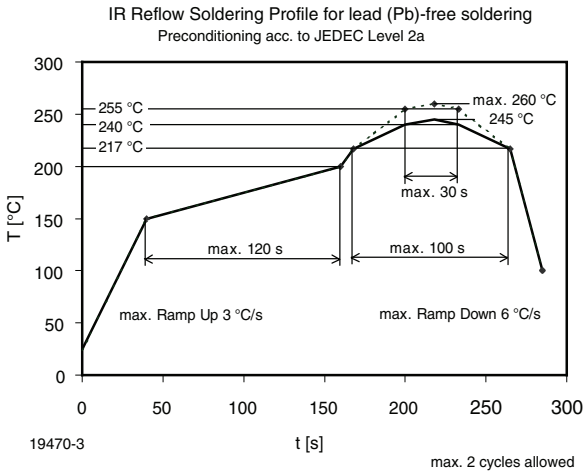
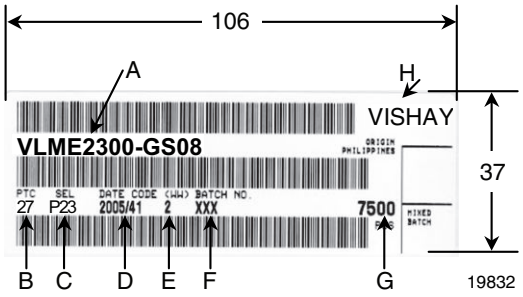


Fig. 18 - Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020)

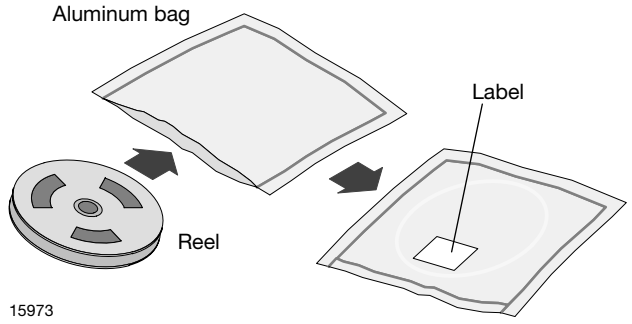
BAR CODE PRODUCT LABEL (example)



A. Type of component
B. Manufacturing plant
C. SEL - selection code (bin):
e.g.: J2 = code for luminous intensity group
4 = code for color group
d. Date code year / week
E. Day code (e.g. 2: Tuesday)
F. Batch no.
G. Total quantity
H. Company code

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

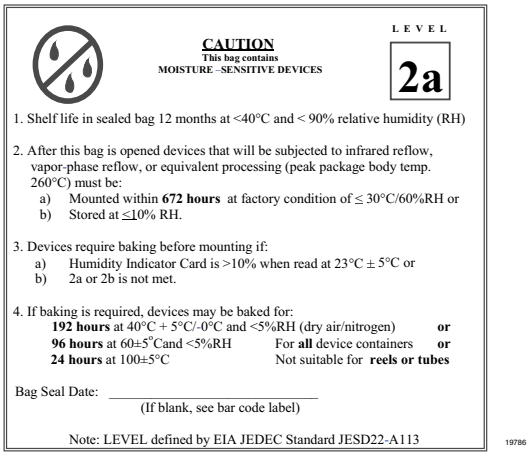
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen)
or
96 h at 60 °C + 5 °C and < 5 % RH for all device containers
or
24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 2a label is included on all dry bags.


CAUTION
This bag contains
MOISTURE–SENSITIVE DEVICES

LEVEL
2a

1. Shelf life in sealed bag 12 months at <40°C and < 90% relative humidity (RH)

2. After this bag is opened devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing (peak package body temp. 260°C) must be:
   a) Mounted within **672 hours** at factory condition of ≤ 30°C/60%RH or
   b) Stored at ≤10% RH.

3. Devices require baking before mounting if:
   a) Humidity Indicator Card is >10% when read at 23°C ± 5°C or
   b) 2a or 2b is not met.

4. If baking is required, devices may be baked for:
   192 hours at 40°C + 5°C/-0°C and <5%RH (dry air/nitrogen) **or**
   96 hours at 60±5°Cand <5%RH For **all** device containers **or**
   24 hours at 100±5°C Not suitable for **reels or tubes**

Bag Seal Date: _____
(If blank, see bar code label)

Note: LEVEL defined by EIA JEDEC Standard JESD22-A113

19786

Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

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